

2.5V/3.3V, High-Bandwidth, Hot-Insertion, 2-Bit, 2-Port Bus Switch w/ Individual Enables

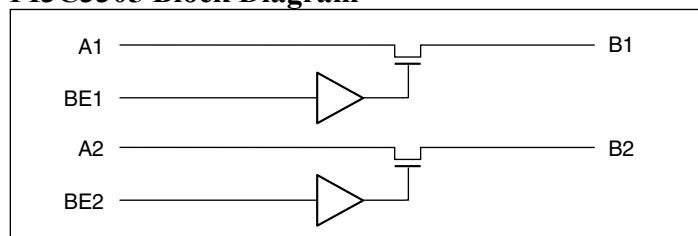
Features

- Near-Zero propagation delay
- 5Ω switches connect inputs to outputs
- High Bandwidth (>400 MHz)
- Rail-to-Rail, 3.3V or 2.5V Switching
- 5V I/O Tolerant
- 2.5V Supply Voltage Operation
- Permits Hot Insertion
- Packaging:
 - 8-pin 173-mil wide plastic TSSOP
 - 8-pin 118-mil wide plastic MSOP

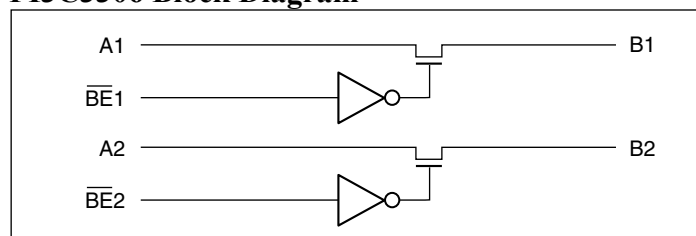
Applications

- High Bandwidth Data Switching
- Hot Docking

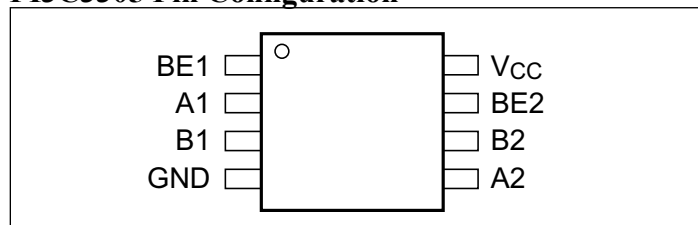
PI3C3305 Block Diagram



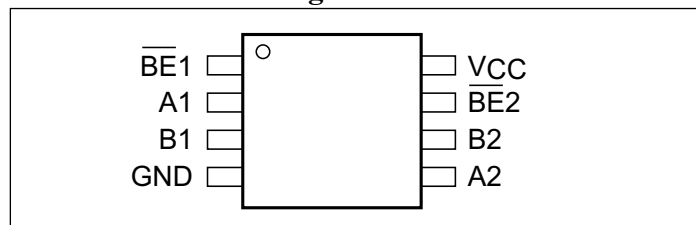
PI3C3306 Block Diagram



PI3C3305 Pin Configuration



PI3C3306 8-Pin Configuration



Truth Table⁽¹⁾

PI3C3306 BE _n	PI3C3305 BE _n	A _n	B _n	V _{CC}	Function
X	X ⁽²⁾	Hi-Z	Hi-Z	GND	Disconnect
H	L	Hi-Z	Hi-Z	V _{CC}	Disconnect
L	H	B _n	A _n	V _{CC}	Connect

Notes:

1. H = High Voltage Level; L = Low Voltage Level;
Hi-Z = High Impedance; X = Don't Care
2. A pull-up resistor should be provided for power-up protection.

Pin Description

Pin Name	Description
BE _n	Switch Enable (PI3C3305)
BE _n	Switch Enable (PI3C3306)
A2-A1	Bus A
B2-B1	Bus B
V _{CC}	Power
GND	Ground

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	−65°C to +150°C
Ambient Temperature with Power Applied	−40°C to +85°C
Supply Voltage to Ground Potential	−0.5V to +4.6V
DC Input Voltage	−0.5V to +5.5V
DC Output Current.....	120mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over Operating Range, $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 3.3\text{V} \pm 10\%$)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	−0.5		0.8	
I_{IH}	Input HIGH Current	$V_{CC} = \text{Max.}, V_{IN} = V_{CC}$			±1	μA
I_{IL}	Input LOW Current	$V_{CC} = \text{Max.}, V_{IN} = \text{GND}$			±1	
I_{OZH}	High Impedance Output Current	$0 \leq A, B \leq V_{CC}$			±1	
V_{IK}	Clamp Diode Voltage	$V_{CC} = \text{Min.}, I_{IN} = -18\text{mA}$		−0.73	−1.2	V
R_{ON}	Switch On Resistance ⁽³⁾	$V_{CC} = \text{Min.}, V_{IN} = 0.0\text{V}, I_{ON} = 48\text{mA}$ or 60mA		5	7	Ω
		$V_{CC} = \text{Min.}, V_{IN} = 2.4\text{V}, I_{ON} = 15\text{mA}$		8	15	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at $V_{CC} = 3.3\text{V}$, $T_A = 25^{\circ}\text{C}$ ambient and maximum loading.
- Measured by the voltage drop between A and B pin at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (A,B) pins.

Capacitance ($T_A = 25^{\circ}\text{C}$, $f = 1\text{ MHz}$)

Parameters ⁽¹⁾	Description	Test Conditions	Typ.	Units
C_{IN}	Input Capacitance	$V_{IN} = 0\text{V}$	3.5	pF
C_{OFF}	A/B Capacitance, Switch Off		5.0	
C_{ON}	A/B Capacitance, Switch On		10.0	

Notes:

- This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units
I_{CC}	Quiescent Power Supply Current	$V_{CC} = \text{Max.}$ $V_{IN} = \text{GND}$ or V_{CC}		260	500	μA
ΔI_{CC}	Supply Current per Input HIGH	$V_{CC} = \text{Max.}$ $V_{IN} = 3.0\text{V}^{(3)}$			750	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at $V_{CC} = 3.3\text{V}$, $+25^{\circ}\text{C}$ ambient.
- Per driven input (control input only); A and B pins do not contribute to ΔI_{CC} .

Switching Characteristics over 3.3V Operating Range

Parameters	Description	Test Conditions ⁽¹⁾	3305/3306		Units
			Com		
			Min.	Max.	
t _{PLH} t _{PHL}	Propagation Delay ^(2, 3) A to B, B to A	C _L = 50pF R _L = 500Ω		0.25	ns
t _{PZH} t _{PZL}	Bus Enable Time	C _L = 50pF R _L = 500Ω	1.5	6.5	
t _{PHZ} t _{PLZ}	Bus Disable Time	R = 500Ω	1.5	5.5	

Notes:

- See test circuit and waveforms.
- This parameter is guaranteed but not tested on Propagation Delays.
- The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

Switching Characteristics over 2.5V Operating Range

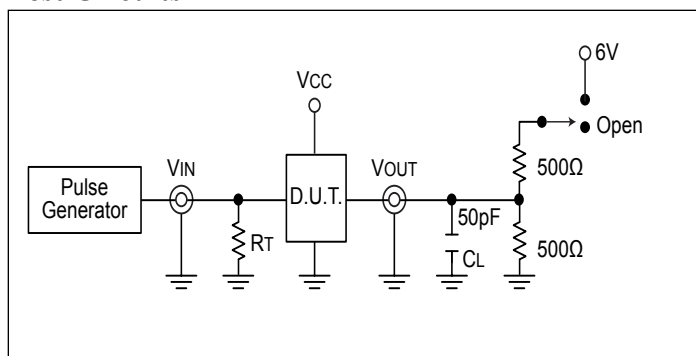
Parameters	Description	Test Conditions ⁽¹⁾	3305/3306		Units
			Com		
			Min.	Max.	
t _{PLH} t _{PHL}	Propagation Delay ^(2, 3) A to B, B to A	C _L = 50pF R _L = 500Ω		0.25	ns
t _{PZH} t _{PZL}	Bus Enable Time	C _L = 50pF R _L = 500Ω	1.5	9.8	
t _{PHZ} t _{PLZ}	Bus Disable Time	R = 500Ω	1.5	8.3	

Notes:

- See test circuit and waveforms.
- This parameter is guaranteed but not tested on Propagation Delays.
- The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

PI3C3305/PI3C3306

Test Circuits



Switch Position

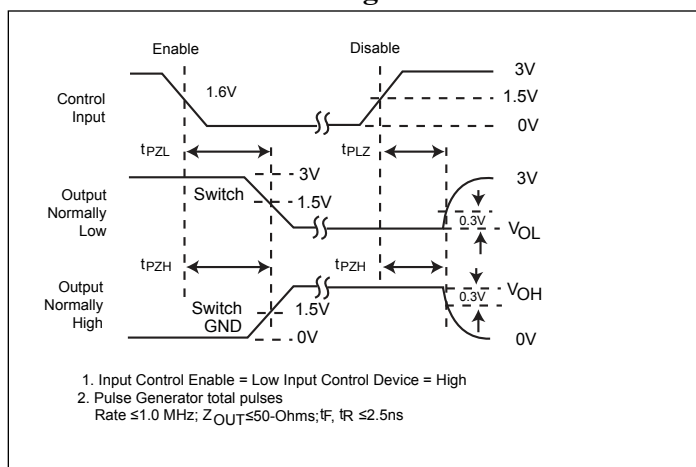
Test	Switch
Disable LOW	6V
Enable LOW	6V
Disable HIGH	GND
Enable HIGH	GND
tPD	Open

Definitions:

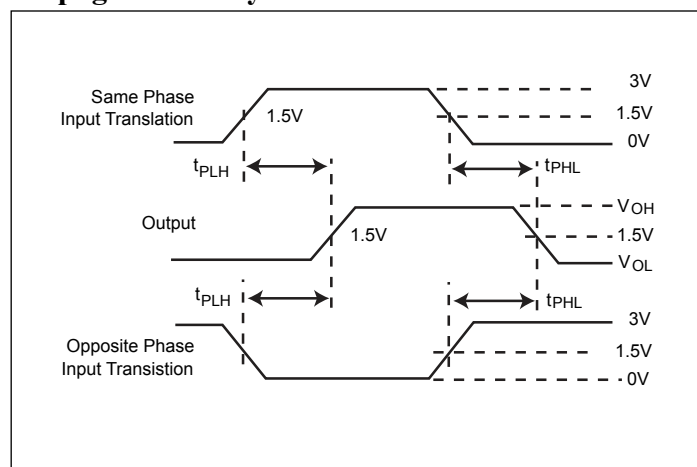
C_L = Load capacitance (includes jig and probe capacitance)

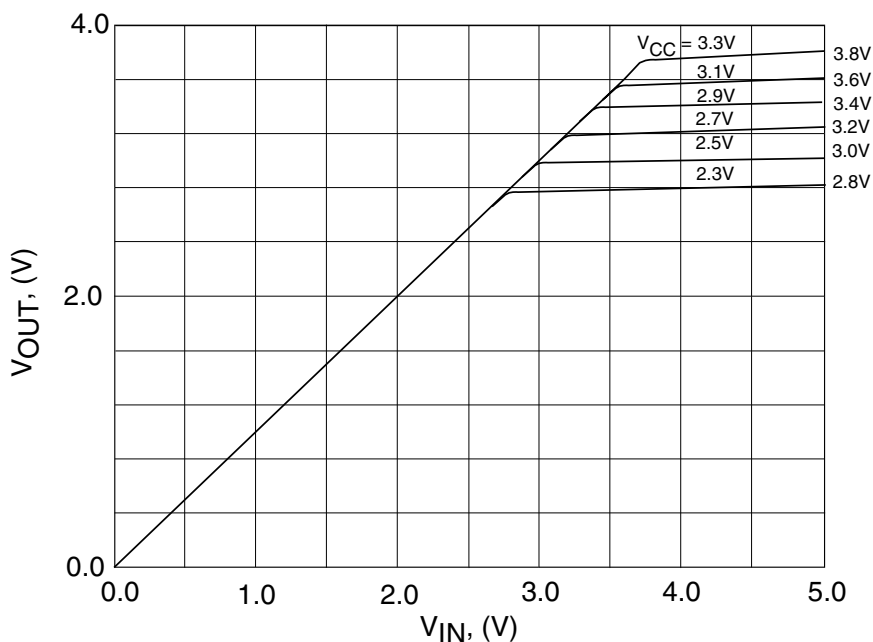
R_T = Termination resistance (should be equal to Z_{OUT} of the pulse generator)

Enable and Disable Timing



Propagation Delay





Output Voltage vs. Input Voltage over Various Supply Voltages

Application Information

Logic Inputs

The logic control input can be driven up to +3.6V regardless of the supply voltage. For example, given a +3.3V supply, IN may be driven LOW to 0V and HIGH to 3.6V. Driving IN Rail-to-Rail® minimizes power consumption.

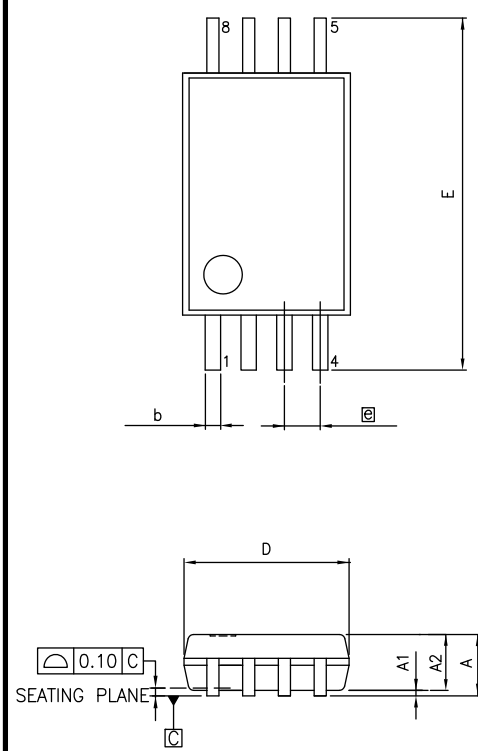
Power-Supply Sequencing

Proper power-supply sequencing is advised for all CMOS devices. It is recommended to always apply V_{CC} before applying signals to the input/output or control pins.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

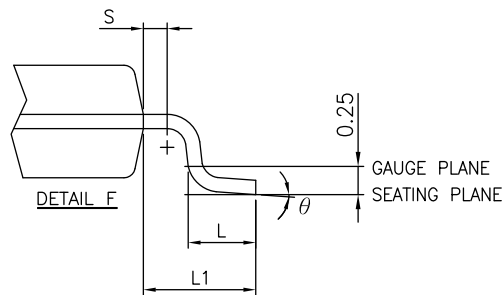
PI3C3305/PI3C3306

Packaging Mechanical: 8-Pin TSSOP (L)



SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.20
A1	0.05	—	0.15
A2	0.80	1.00	1.05
b	0.19	—	0.30
c	0.09	—	0.20
D	2.90	3.00	3.10
E	6.20	6.40	6.60
e	0.65 BSC		
E1	4.30	4.40	4.50
L	0.45	0.60	0.75
L1	1.00 REF		
S	0.20	—	—
θ°	0	—	8

UNIT : MM



NOTES:

1. ALL DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.
2. JEDEC MO-153F/AA
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



DATE: 03/24/16

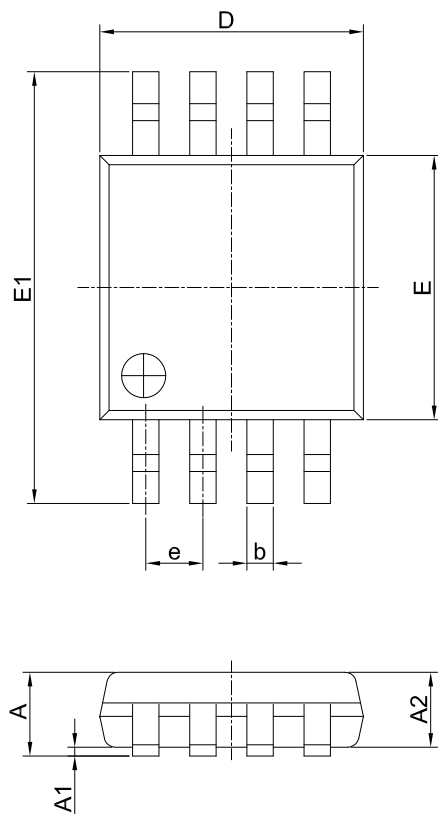
DESCRIPTION: 8-Pin, 173mil Wide TSSOP

PACKAGE CODE: L (L8)

DOCUMENT CONTROL #: PD-1308

REVISION: G

16-0062

PI3C3305/PI3C3306
Packaging Mechanical: 8-Pin MSOP (U)


PKG. DIMENSIONS(MM)		
SYMBOL	Min.	Max.
A	—	1.10
A1	0.00	0.15
A2	0.75	0.95
b	0.22	0.38
c	0.08	0.23
D	2.90	3.10
E	2.90	3.10
E1	4.65	5.15
e	0.65 BSC	
L	0.40	0.80
θ	0°	8°

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. REFER JEDEC MO-187E/AA
3. PACKAGE OUTLINE DIMENSIONS DO NOT INCLUDE MOLD FLASH AND METAL BURR.



DATE: 10/20/14

DESCRIPTION: 8-Pin, Mini Small Outline Package, MSOP
PACKAGE CODE: U (U8)
DOCUMENT CONTROL #: PD-1261
REVISION: E

For latest package info.

 please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>
Ordering Information

Ordering Code	Package Code	Description
PI3C3305LEX	L	8-pin 173-mil wide (TSSOP)
PI3C3305UEX	U	8-pin, Mini Small Outline Package (MSOP)
PI3C3306LEX	L	8-pin 173-mil wide (TSSOP)
PI3C3306UEX	U	8-pin, Mini Small Outline Package (MSOP)

Notes:

- Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel

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